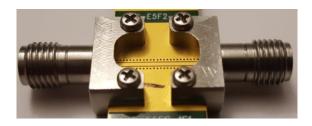


Test and Measurement Performance Report

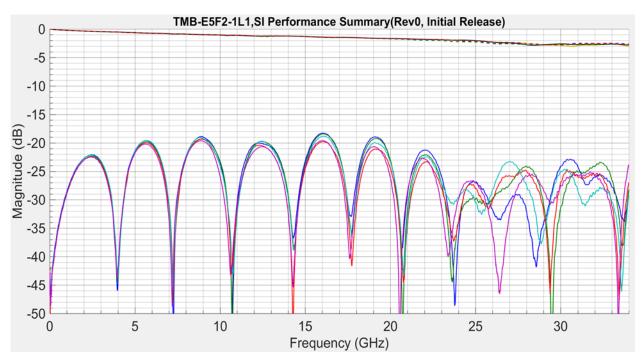
Part Number TMB-E5F2-1L1

(3.5mm Edge Launch Solderless Precision Connector)

Distribution: Internal & External Use



SI Performance Summary (Attenuation & Reflections, Single-Ended)



* 10 connectors are shown, measured in pairs. (5 measurements) For further details regarding testing setup, configurations please see the rest of the report.

REVISION:	ECN INFORMATION: EC No: N/A DATE: 04/13 / 2020	3.5mm Edge Precision Co CARLISLE IT CON	nnector (TMB-E5F		1 of 10
DOCUMENT NUMBER:		SI ENGINEER:	DESIGN ENGINEER	ENGINEERING	MANAGER
RSI-TMB-E5F2-1L1_01		R.Stavoli	P. Volkov E.Soubh		u bh
			TEMF	LATE FILENAME: SPM	[SIZE_A](V.1).DOC



1.0 TEST SETUP AND DUT

Equipment, fixtures, and methods

Test method: All data measured from test PCB shown below and a N5227A PNA Network Analyzer

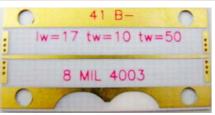
- Calibration was performed up to the 2.
 92mm adapters using calibration kit:
 8770F
- Data was swept from 10 MHz to 34GHz for 3400 points
- Data averaging was turned off.
- Data is not dembedded and includes the board trace/transition and two RF edge launch precision connectors



Assembly Description

- T&M PN: TMB-E5F2-1L1
- Carlisle DUT PCB: Edge Launch Precision Connector Test Board (Rev A)
- Industry Leading Supplier Edge Launch PCB (B4003-8M-50)
- Port 1: 3.5mm edge mount
- Port 2: 3.5mm edge mount





Testing Samples:

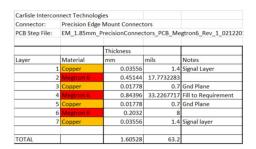
- 10 Samples
- 5 Channels
- 5 THRU Measurements (5 Channels = 10 samples) -> -Single-Ended

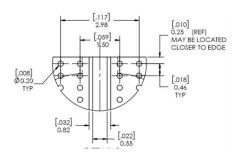
REVISION:	ECN INFORMATION: EC No: N/A DATE: 04/ 13 / 2020	3.5mm Edge Precision Co CARLISLE IT CON	2 of 10		
DOCUMENT NUMBER:		SI ENGINEER:	DESIGN ENGINEER	ENGINEERIN	<u>G MANAGER</u>
RSI-TMB-E5F2-1L1_01		R.Stavoli	P. Volkov E.Soubh		ubh
			TEMF	LATE FILENAME: SPN	I[SIZE A](V.1).DOC

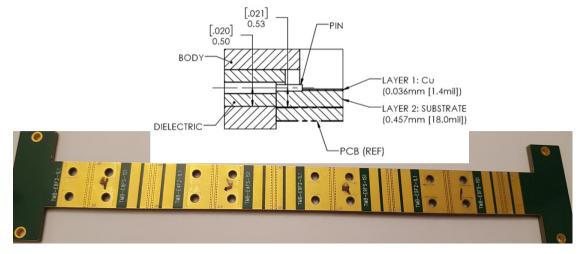


2.0 BOARD DETAILS & STACKUP

- Carlisle Edge Launch Precision Connector Test Board
 - Revision A, Coplanar Waveguide
 - o Copper (traces, pads, ground) not all the way to the edge of the board
- Dielectric Material: Megtron6 (Dk.3.41, Df 0.004 @ 12Ghz)
 - Thickness: 0.457mm / 18 mil







- Industry Leading Supplier Edge LaunchTest Board, B4003-8M-50
 - Microstrip
- Dielectric Material: Rodgers 4003 (Dk. 3.38, Df 0.0027 @ 10Ghz)
 - Thickness: 0.2032mm / 8 mil



REVISION:	EC No: N/A DATE: 04/13 / 2020	3.5mm Edge Launch, Solderless Precision Connector (TMB-E5F2-1L1) CARLISLE IT CONFIDENTIAL			3 of 10
DOCUMENT NUMBER:		SI ENGINEER:	DESIGN ENGINEER	ENGINEERING	<u> MANAGER</u>
RSI-TMB-E5F2-1L1_01		R.Stavoli	P. Volkov	E.Soubh	
			TEMF	LATE FILENAME: SPM	[SIZE_A](V.1).DOC



3.0 MEASUREMENT SET-UP

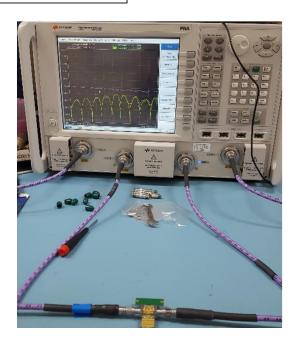
Port 1:

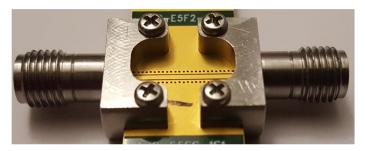
TMB-E5F2-1L1
3.5mm Edge Launch
Solderless Precision
Connector # 1 A

Edge Launch Test Board

Port 2:

TMB-E5F2-1L1
3.5mm Edge Launch
Solderless Precision
Connector # 1 B







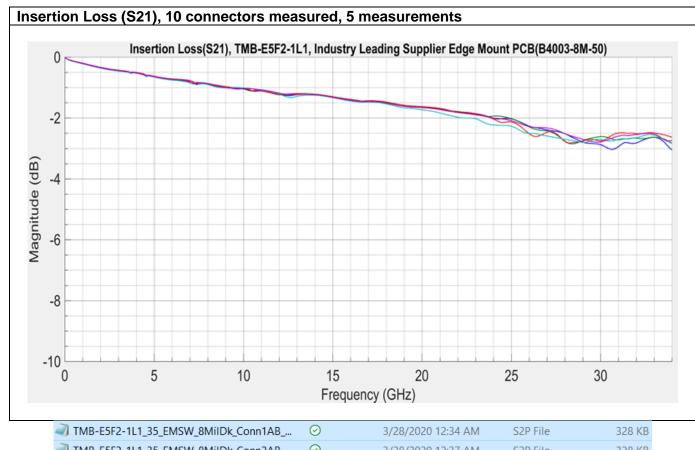
Measurements are not dembedded and include the two 3.5mm edge launch precision connectors, and the PCB (transition, traces)

REVISION:	ECN INFORMATION: EC No: N/A DATE: 04/13 / 2020	3.5mm Edge Precision Co CARLISLE IT CON	SHEET No. 4 of 10		
DOCUMENT NUMBER:		SI ENGINEER:	DESIGN ENGINEER	ENGINEERING	<u>G MANAGER</u>
RSI-TMB-E5F2-1L1_01		R.Stavoli	P. Volkov E.Soubh		u bh
			TEMF	LATE FILENAME: SPM	[SIZE_A](V.1).DOC



4.0 SIGNAL INTEGRITY RESULTS (INDUSTRY LEADING SUPPLIER PCB ,8MIL DIELECTRIC THICKNESS)

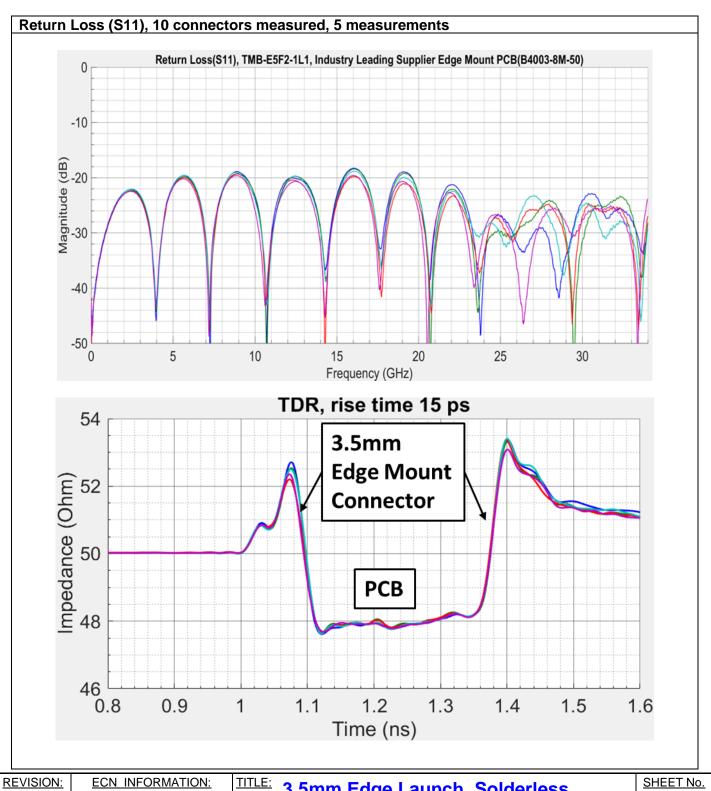




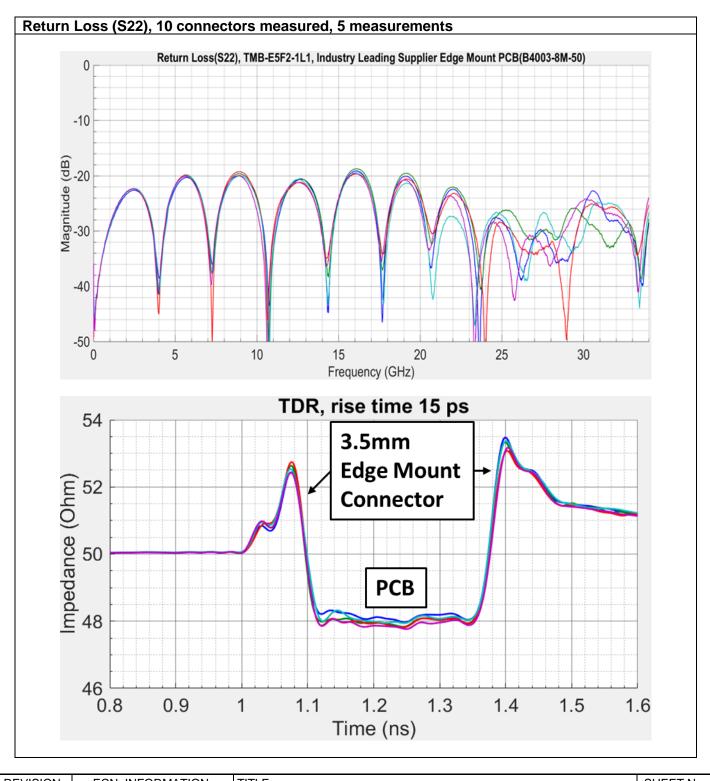
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⊘	3/28/2020 12:37 AM	S2P File	328 KB
⊘	3/28/2020 12:39 AM	S2P File	328 KB
⊘	3/28/2020 12:42 AM	S2P File	328 KB
⊘	3/28/2020 12:47 AM	S2P File	328 KB
	OOO		 ⊙ 3/28/2020 12:37 AM S2P File ⊙ 3/28/2020 12:39 AM S2P File ⊙ 3/28/2020 12:42 AM S2P File

REVISION:	ECN INFORMATION: EC No: N/A DATE: 04/ 13 / 2020	3.5mm Edge Precision Co CARLISLE IT COM	5 of 10		
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RSI-TMB-E5F2-1L1_01		R.Stavoli	P. Volkov E.Soubh		ubh
			TEM	LATE FILENAME: SPN	I[SIZE A](V.1).DOC





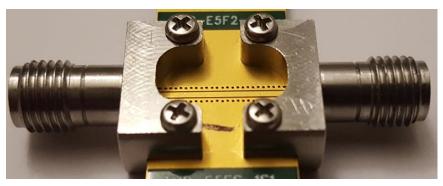


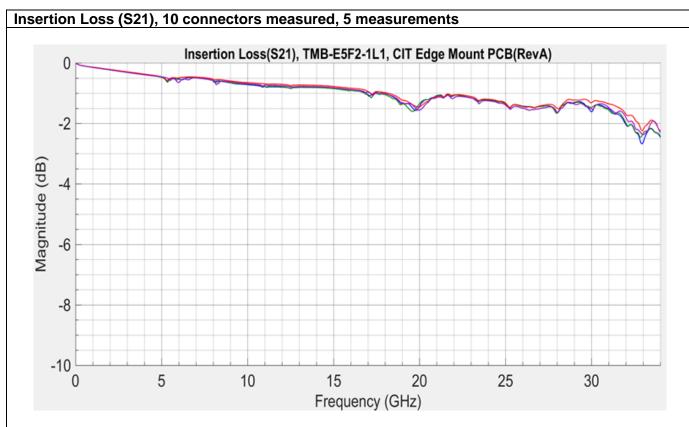


	1	EC No: N/A DATE: 04/ 13 / 2020	3.5mm Edge Precision Co CARLISLE IT CON	7 of 10		
DO	DOCUMENT NUMBER:		SI ENGINEER:	DESIGN ENGINEER	ENGINEERIN	G MANAGER
R	RSI-TMB-E5F2-1L1_01		R.Stavoli	P. Volkov E.Soubh		ubh
				TEMF	LATE FILENAME: SPN	//[SIZE_A](V.1).DOC



5.0 SIGNAL INTEGRITY RESULTS (CIT PCB, 18MIL DIELECTRIC THICKNESS)

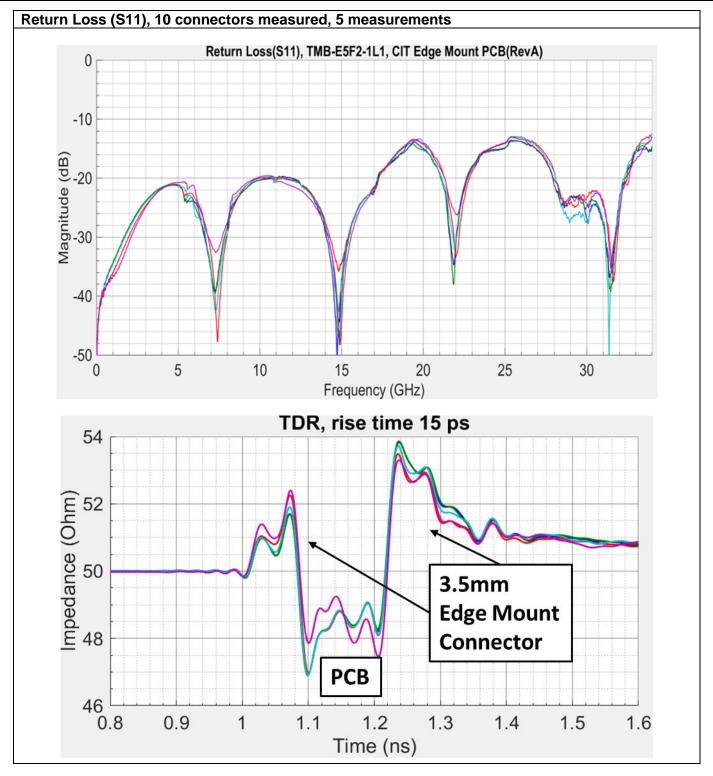




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TMB-E5F2-1L1_35_EMRevA0_18MilDk_Lo1_Conn3AB_P1SideB_P2SideA	4/10/2020 1:20 PM	S2P File	421 KB
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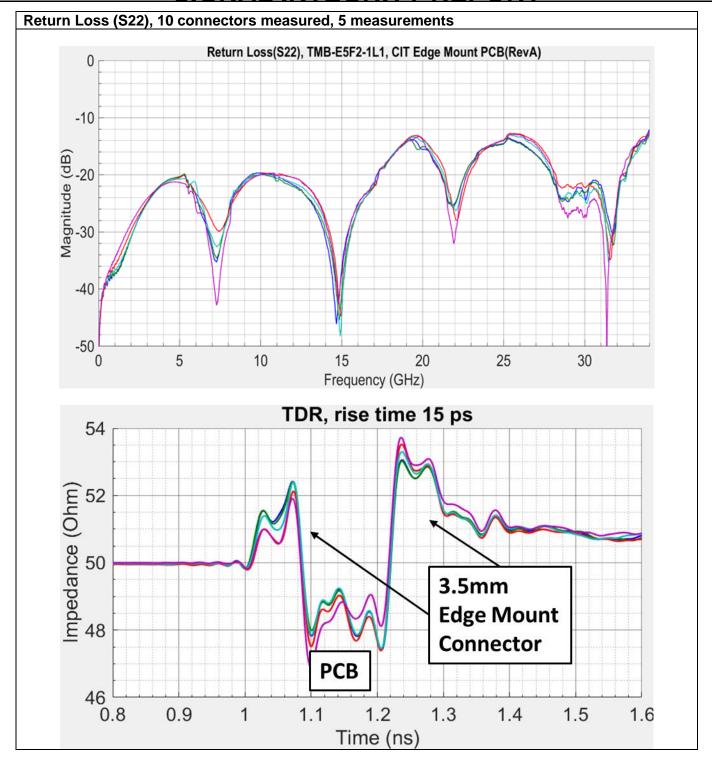
REVISION:	ECN INFORMATION: EC No: N/A DATE: 04/ 13 / 2020	3.5mm Edge Launch, Solderless Precision Connector (TMB-E5F2-1L1) CARLISLE IT CONFIDENTIAL			8 of 10
DOCUMENT NUMBER:		SI ENGINEER:	DESIGN ENGINEER	ENGINEERING	<u>G MANAGER</u>
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	TEMPLATE FILENAME: SPM[SIZE_A](V.1).D				//[SIZE_A](V.1).DOC		





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DOCUMENT NUMBER:		SI ENGINEER:	DESIGN ENGINEER	ENGINEERING	MANAGER	
RSI-TMB-E5F2-1L1_01		R.Stavoli	P. Volkov E.Soubh		ubh	
			TEMPLATE FILENAME: SPM[SIZE_A](V.1).DOC			